ANNOUNCEMENT
Regarding the
Chinese Government Scholarships

GENERAL

The attached announcement is to be sent to all public and independent schools of the province, as well to the Ministry of Advanced Education and Labour Market Development for communication to post-secondary institutes.

ANNOUNCEMENT

The Chinese Government, in collaboration with the Ministries of Education and Advanced Education and Labour Market Development of the Province of British Columbia, is offering scholarships for eligible BC students to study abroad.

The purpose of the scholarships is to strengthen mutual understanding and friendship between the Chinese people and people from the whole world, and to develop cooperation and exchange in the fields of education, science, culture, economy and trade between China and other countries.

Full and partial scholarships are offered to successful applicants to study in China.

Categories of scholarship support include study in undergraduate, master’s degree, and doctoral degree programs, as well as support for those pursuing studies in Chinese language, general studies, as well as further study for senior scholarship candidates already holding a master’s degree or higher. Eligibility criteria, application forms and procedures and further information about the Chinese Government Scholarship are contained at the Ministry of Education website at: http://www.bced.gov.bc.ca/offshore_schools/os_scholar.htm and the Ministry of Advanced Education and Labour Market Development website at: http://www.aved.gov.bc.ca/studentaidbc/specialprograms/scholarships.htm

To facilitate this partnership with the Chinese government, the Province of British Columbia has appointed a Chinese Scholarship Committee mandated to adjudicate applications and inform the Ministries of Education and Advanced Education and Labour Market Development, as well as the Education Consul at the Consulate General of the People’s Republic of China in Vancouver, British Columbia, of the successful applicants. British Columbia applications must be submitted by March 1, 2009.